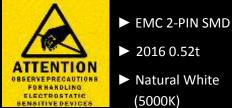


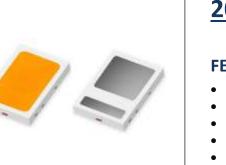


PRODUCT DATASHEET



- ▶ 2016 0.52t
- Natural White (5000K)





2016 EMC Series

APPLICATIONS:

N0W26S14

- **General Lighting** •
- Portable Lighting
- **Commercial Lighting** •
- Indoor Lighting •
- Backlight for LCD •

2016 EMC Series



FEATURES:

- Package: Top View EMC White Package
- Forward Current: 60mA
- Forward Voltage (typ.): 6.1V
- Luminous Flux (typ.): 48lm@60mA
- Colour: Natural White
- Colour Temperature (CCT): 5000K .
- Viewing angle: 110° •
 - Materials:

.

- Die: InGaN _
- _ Resin: Silicon (Yellow Diffused) _ Package: EMC
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+85°C
- Electrostatics Discharge: 1000V
 - **Grouping parameters:**
 - Forward Voltage _
 - Luminous Flux _
 - **CIE Chromaticity** _
- Soldering methods: Reflow Soldering
- MSL Level: MSL3 according to J-STD020
- Packing: 8mm tape with Max. 5000/reel, ø165mm (6.5")





CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C, RH=60%)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	100	mA
Pulse Forward Current (Duty 1/10, width≤100µS)	I _{PF}	160	mA
Power Dissipation	P _D	650	mW
Reverse Voltage	V _R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	115	°C
Electrostatic Discharge	ESD	1000	V
Thermal Resistance (Junction to Solder Point)	R _{THJS}	22	°C/W
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+85	°C
Soldering Temperature	T _{SOL}	230/260 for 10S	°C
Colour Rendering Index	CRI	80	

Electrical & Optical Characteristics (Ta=25°C, RH=60%)

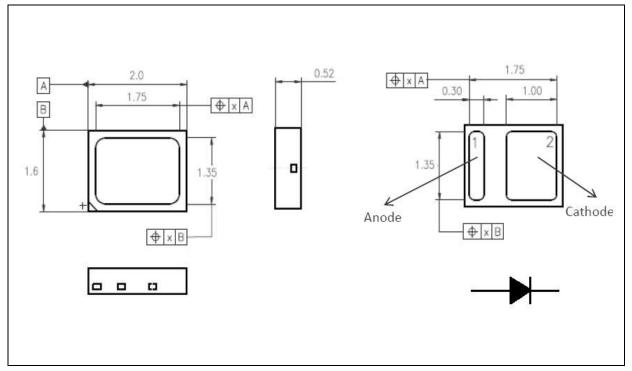
Parameter	Symbol	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Omt	Condition	
Forward Voltage	$V_{\rm F}$	5.5	6.1	6.5	V	I _F =60mA	
Luminous Flux	Φν	42	48	54	lm	I _F =60mA	
Chromaticity	х		0.3451			I _F =60mA	
Coordinates	Y		0.3554				
Colour Temperature	ССТ	4745	5028	5311	К	I _F =60mA	
Viewing Angle	20 _{1/2}		110		deg	I _F =60mA	

1. Luminous flux (Φ_v) ±10%, Forward Voltage (V_F) ±0.1V



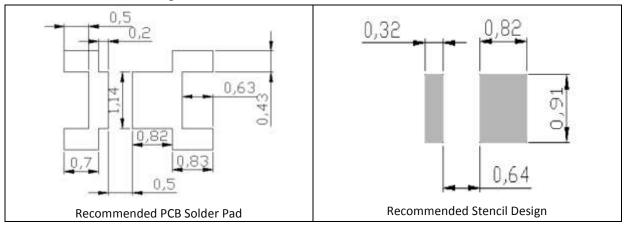
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



1. Dimensions are in millimetre (mm).

3

2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Forward Voltage Classifications ($I_F = 60 \text{mA}$):

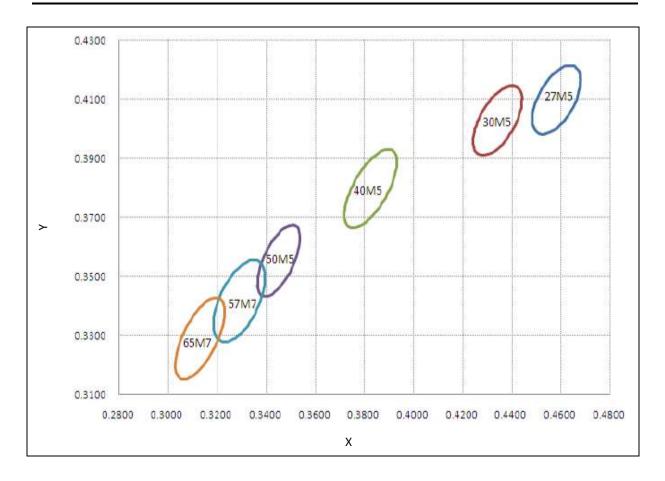
Code	Min.	Max.	Unit	
С	5.5	6.0	N/	
D	6.0	6.5		

Luminous Flux Classifications (I_F = 60mA):

Code	Min.	Max.	Unit
E4	42	46	
E5	46	50	lm
E6	50	54	



CIE CHROMATICITY DIAGRAM:

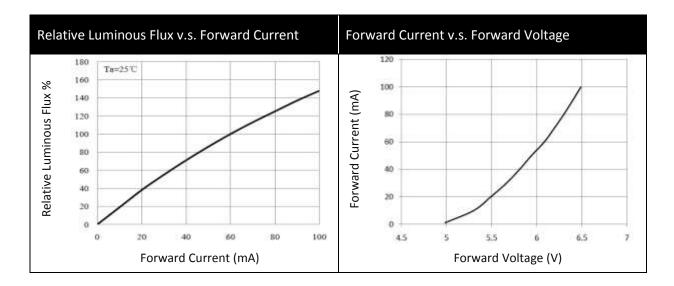


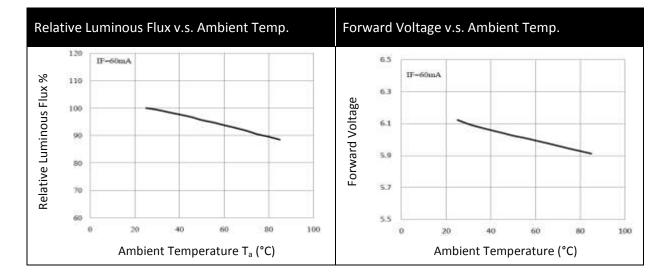
Chromaticity Coordinates Classifications (I_F = 60mA):

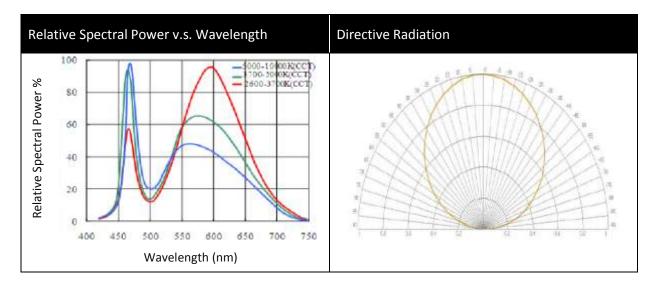
\sim	Codo	Centre		Radius		Angle
(a/)	Code	Х	Y	а	b	Φ
B D D	50M5	0.3451	0.3554	0.013700	0.005900	59.37



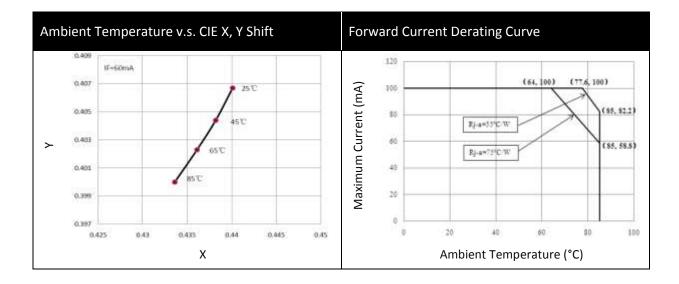
ELECTRO-OPTICAL CHARACTERISTICS:





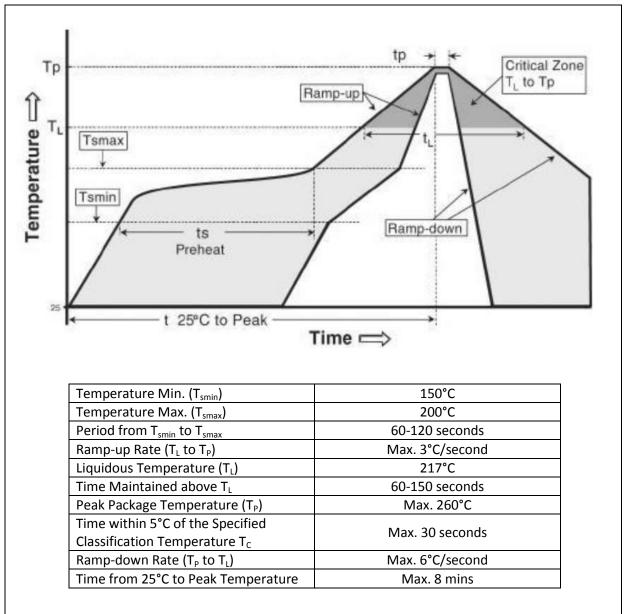








RECOMMENDED SOLDERING PROFILE:



Reflow Lead-free Solder:

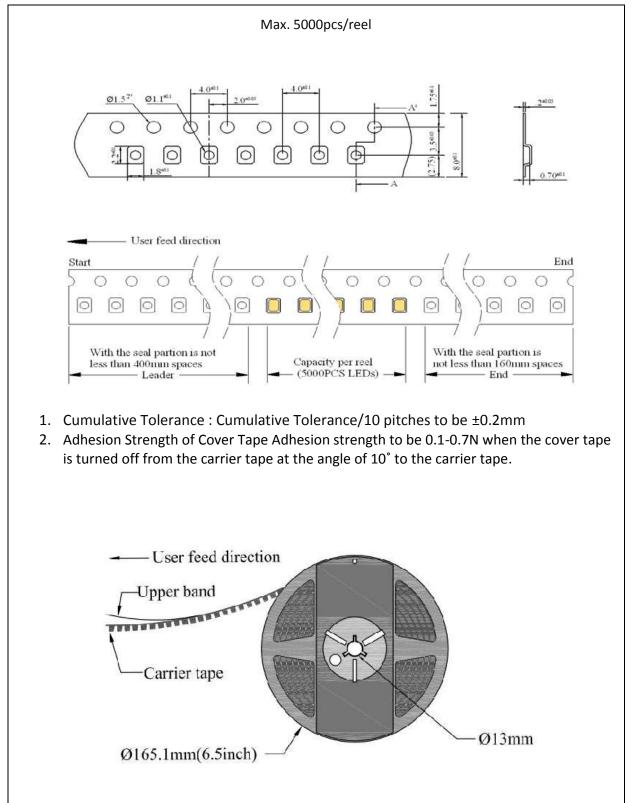
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.



PACKING SPECIFICATION:

Reel Dimension:



PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

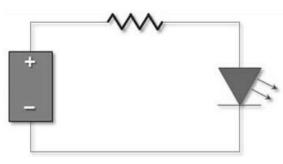
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 70±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	17/02/2016	Datasheet set-up.